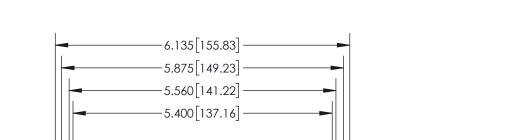
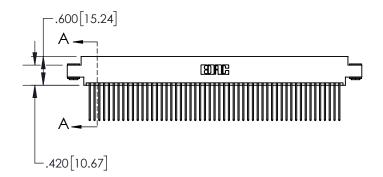
Contact Dimensions: 541-Wire Wrap .025 Sq.(0.64 Sq.) - Tail LG=.750(19.05) .100 (2.54) Contact Spacing x .200 (5.08) Row Spacing



-2x Ø.156[3.96] **—**.100[2.54]

CARD SLOT ACCEPTS -.054" [1.37] TO .070"[1.78] THICK PCB



.330[8.38] **CARD SLOT** .370 [9.40] **SECTION A-A** .160 4.06 POINT OF .150 [3.8] **CONTACT**

- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY
 CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING
 ON THE CONTACT TAILS, NICKEL UNDERPLATE

| 845/895 | SERIES HIGH TEM | P CARD | EDGE | CONNECT | OR |
|---------|------------------|--------|------|---------|----|
| PART NU | MBFR: 895-106-54 | 41-803 | | | |

YOUR CONNECTION TO QUALITY & SERVICE

| ACAD REFERENCE NO. 845-ENG-MASTER | | | | | |
|-----------------------------------|------------------|--|--|--|--|
| DRAWN: R.STA.MONICA | DATE:MAY.16/2017 | | | | |
| CHECKED: | DATE: | | | | |
| SCALE: 1:2 | SHEET 1 OF 2 | | | | |
| DRAWING NUMBER | ISSUE | | | | |

-.200 [5.08]

845-ENG-MASTER







- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL; COPPER ALLOY

CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

| | ACAD REFERENCE NO | . 845-ENG-MASTER |
|---|---------------------|------------------|
| | DRAWN: R.STA.MONICA | DATE:MAY.16/2017 |
| | CHECKED: | DATE: |
| | SCALE: 1:1 | SHEET 2 OF 2 |
| D | DRAWING NUMBER | ISSUE |

845-ENG-MASTER